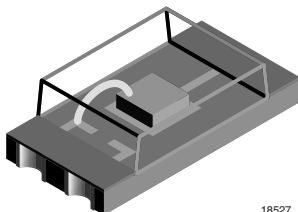


## Ambient Light Sensor



18527

### FEATURES

- Package type: surface mount
- Package form: 1206
- Dimensions (L x W x H in mm): 4 x 2 x 1.05
- AEC-Q101 qualified
- High photo sensitivity
- Adapted to human eye responsivity
- Angle of half sensitivity:  $\varphi = \pm 60^\circ$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

AUTOMOTIVE  
GRADE

RoHS  
COMPLIANT

GREEN  
(5-2008)\*\*

### Note

\*\* Please see document "Vishay Material Category Policy":  
[www.vishay.com/doc?99902](http://www.vishay.com/doc?99902)

### DESCRIPTION

TEMT6000X01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 1206 package for surface mounting. It is sensitive to visible light much like the human eye and has peak sensitivity at 570 nm.

### APPLICATIONS

Ambient light sensor for control of display backlight dimming in LCD displays and keypad backlighting of mobile devices and in industrial on/off-lighting operation.

- Automotive sensors
- Mobile phones
- Notebook computers
- PDA's
- Cameras
- Dashboards

### PRODUCT SUMMARY

COMPONENT	$I_{PCE}$ ( $\mu A$ )	$\varphi$ (deg)	$\lambda_{0.5}$ (nm)
TEMT6000X01	50	$\pm 60$	440 to 800

### Note

- Test condition see table "Basic Characteristics"

### ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TEMT6000X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	1206

### Note

- MOQ: minimum order quantity

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^\circ C$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		$V_{CEO}$	6	V
Emitter collector voltage		$V_{ECO}$	1.5	V
Collector current		$I_C$	20	mA
Power dissipation		$P_V$	100	mW

**ABSOLUTE MAXIMUM RATINGS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction temperature		$T_j$	100	$^{\circ}\text{C}$
Operating temperature range		$T_{amb}$	- 40 to + 100	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	- 40 to + 100	$^{\circ}\text{C}$
Soldering temperature	Acc. reflow solder profile fig. 8	$T_{sd}$	260	$^{\circ}\text{C}$
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	$R_{thJA}$	450	K/W

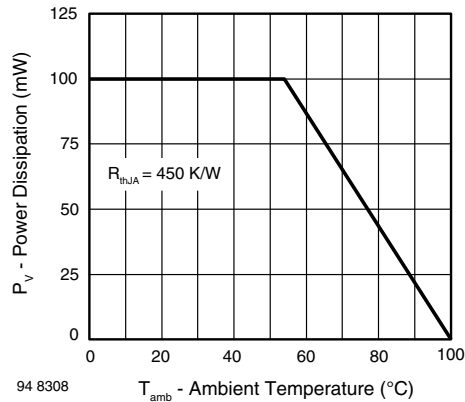


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	$I_C = 0.1\text{ mA}$	$V_{CEO}$	6			V
Collector dark current	$V_{CE} = 5\text{ V}$ , $E = 0$	$I_{CEO}$		3	50	nA
Collector emitter capacitance	$V_{CE} = 0\text{ V}$ , $f = 1\text{ MHz}$ , $E = 0$	$C_{CEO}$		16		pF
Collector light current	$E_V = 20\text{ lx}$ , CIE illuminant A, $V_{CE} = 5\text{ V}$	$I_{PCE}$	3.5	10	16	$\mu\text{A}$
	$E_V = 100\text{ lx}$ , CIE illuminant A, $V_{CE} = 5\text{ V}$	$I_{PCE}$		50		$\mu\text{A}$
Temperature coefficient of $I_{PCE}$	CIE illuminant A	$TK_{IPCE}$		1.18		%/K
	LED, white	$TK_{IPCE}$		0.9		%/K
Angle of half sensitivity		$\phi$		$\pm 60$		deg
Wavelength of peak sensitivity		$\lambda_p$		570		nm
Range of spectral bandwidth		$\lambda_{0.5}$		440 to 800		nm
Collector emitter saturation voltage	$E_V = 20\text{ lx}$ , CIE illuminant A, $I_{PCE} = 1.2\text{ }\mu\text{A}$	$V_{CEsat}$		0.1		V

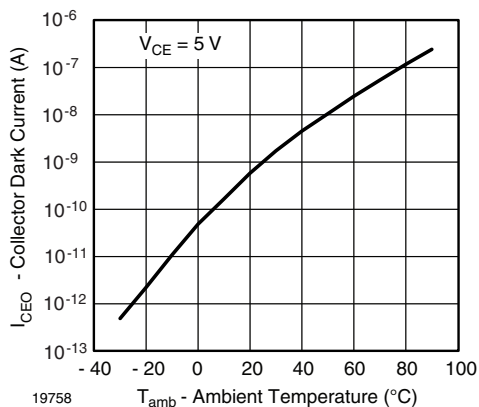
**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - Collector Dark Current vs. Ambient Temperature

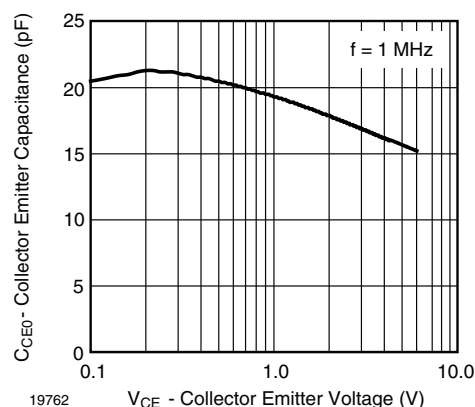


Fig. 4 - Collector Emitter Capacitance vs. Collector Emitter Voltage

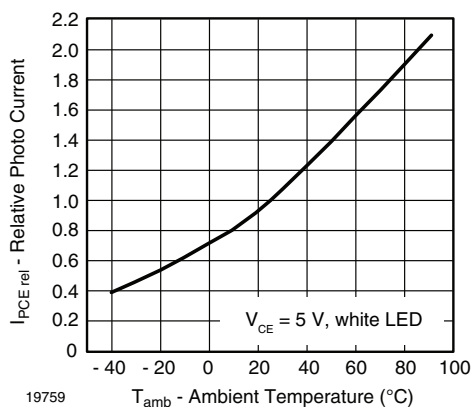


Fig. 2 - Relative Photo Current vs. Ambient Temperature

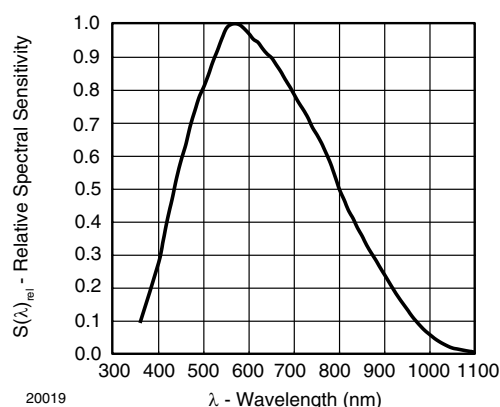


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

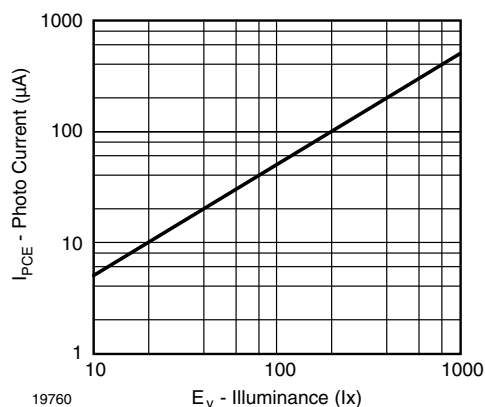


Fig. 3 - Photo Current vs. Illuminance

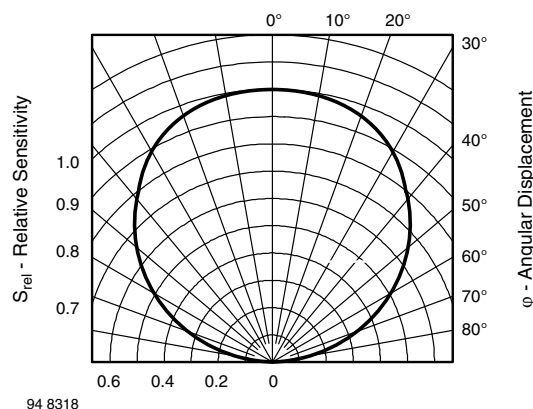


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement

## REFLOW SOLDER PROFILE

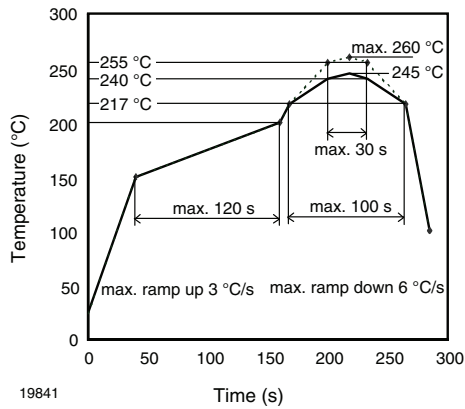


Fig. 7 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020D

## DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

## FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:

Moisture sensitivity: level 3

Floor life: 168 h

Conditions:  $T_{amb} < 30^{\circ}\text{C}$ , RH < 60 %

## DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label.

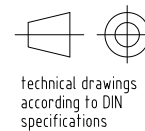
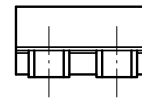
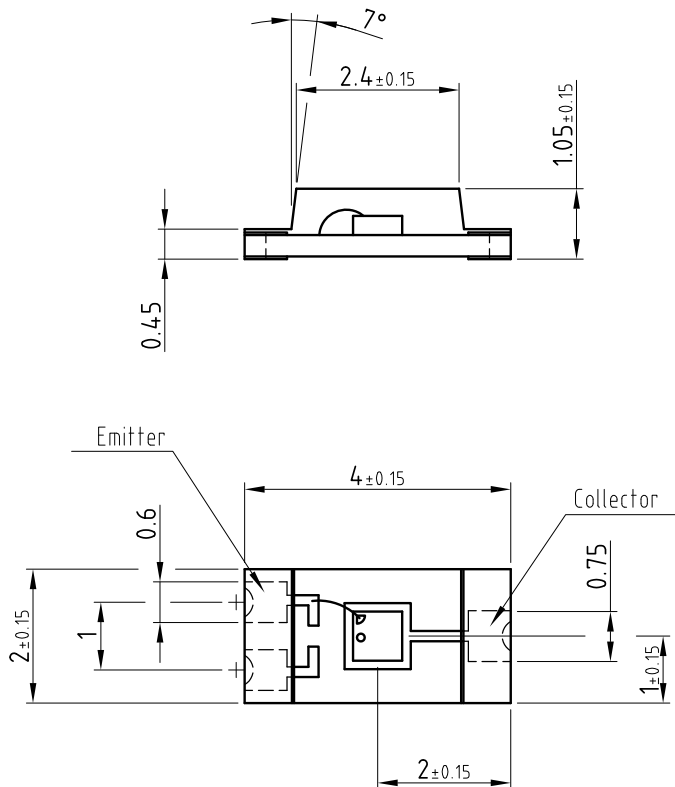
Devices taped on reel dry using recommended conditions:

192 h at  $40^{\circ}\text{C}$  (+ 5  $^{\circ}\text{C}$ ), RH < 5 %

or

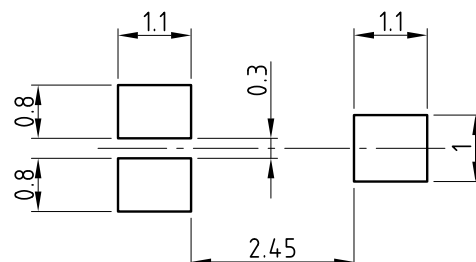
96 h at  $60^{\circ}\text{C}$  (+ 5  $^{\circ}\text{C}$ ), RH < 5 %.

## PACKAGE DIMENSIONS in millimeters



Not indicated tolerances  $\pm 0.1$

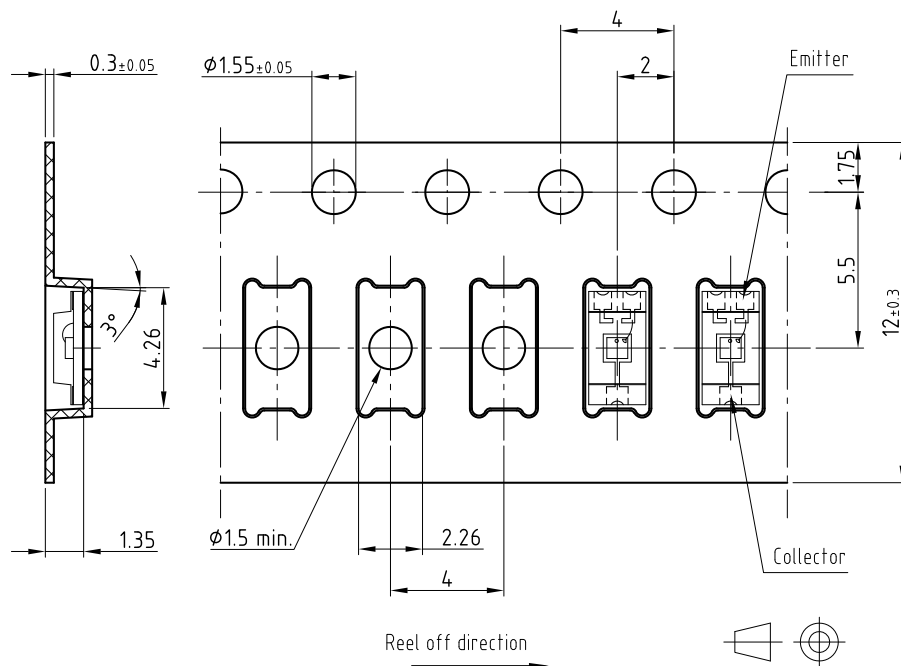
Recommended solder pad  
Footprint



Drawing-No.: 6.541-5053.01-4

Issue: 4; 05.05.08

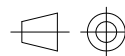
18464

**BLISTER TAPE DIMENSIONS** in millimeters


Drawing-No.: 9.700-5329.01-4

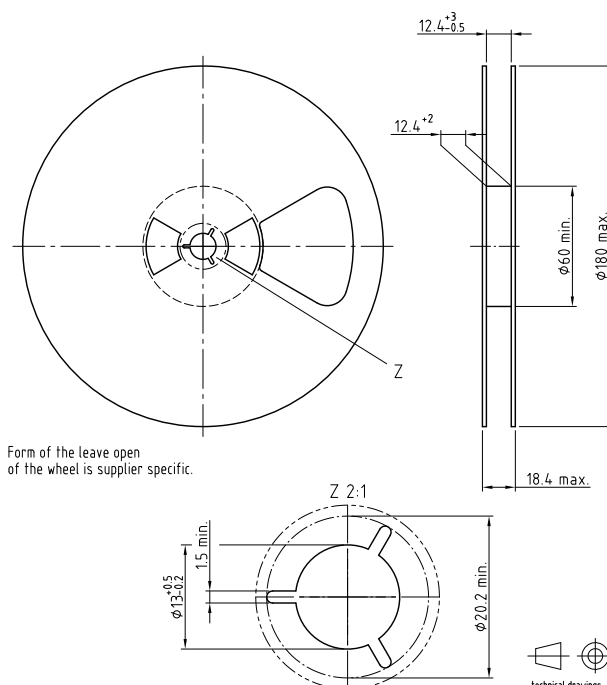
Issue: 1; 05.05.08

20876


technical drawings  
according to DIN  
specifications

Not indicated tolerances  $\pm 0.1$ 
**REEL DIMENSIONS** in millimeters

Volume: 3000 pcs/reel



Drawing-No.: 9.800-5097.01-4

Issue: 1; 05.05.08

20874


technical drawings  
according to DIN  
specifications



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